PATENT APPLICATION TRANSMITTAL LETTER

(Large Entity)

Docket No. ITL.1119US (P18791)

S. PTO

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith for filing under 35 U.S.C. 111 and 37 C.F.R. 1.53 is the patent application of:

Brian Taggart, Robert M. Nickerson, and Ronald I. Spreitzer

For: Lower Profile Flexible Substrate Package for Electronic Components

22859 U.S. PTC 10/807830

Enclosed a	are:
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- ☑ Certificate of Mailing with Express Mail Mailing Label No. EL 990 136 145 US
- ☐ A certified copy of a

application.

- ☑ Declaration
- ⊠ Signed.
- ☐ Unsigned.
- ☐ Information Disclosure Statement
- □ Preliminary Amendment
- ☑ Other: Assignment Documents.

CLAIMS AS FILED

, For	#Filed	#Allowed	#Extra		Rate	Fee
Total Claims	29	- 20 =	9	x	\$18.00	\$162.00
Indep. Claims	3	- 3 =	0	x	\$86.00	\$0.00
Multiple Dependent Claims (check if applicable)						\$0.00
					BASIC FEE	\$770.00
					TOTAL FILING FEE	\$932.00

- A check in the amount of
- \$932.00

to cover the filing fee is enclosed.

☑ The Director is hereby authorized to charge and credit Deposit Account No. as described below.

20-1504

- described below.
- ☐ Charge the amount of

as filing fee.

- ☑ Credit any overpayment.
- □ Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17.
- ☐ Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance, pursuant to 37 C.F.R. 1.311(b).

Dated: March 24, 2004

Timothy N. Arop, Reg. No. 28,994

Trop, Pruner & Hu, P.C.

8554 Katy Freeway, Suite 100

Houston, Texas 77024

(713) 468-8880

(713) 468-8883 (fax)

cc: